



T-CARD PIN NO.	DESCRIPTION
T1	DAT2
T2	CD/DAT3
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1

SIM CARD PIN NO.	DESCRIPTION
N1/M1	VCC
N2/M2	RST
N3/M3	CLK
N5/M5	GND
N6/M6	VPP
N7/M7	I/O
D1	DETECT

- MATERIAL:**
Housing: LCP, Black, UL94 V-0
Contact: Phosphor Bronze, T=0.10±0.01mm
Shell: Stainless Steel, T=0.12±0.01mm
Crank: Stainless Steel, T=0.40±0.01mm
- FINISH:**
Contact: 50U" Ni Min. under plated over all
Gold flash 1~3U" on contact area and solder area
Shell: 30U" Ni Min. under plated over all
Gold flash 1~3U" on solder area
- All dimensions marked ▼ must be controlled by QC
- RATED PARAMETERS OF CONNECTOR:**
4-1. Operating Temperature: -55° C to 85° C
4-2. Rated Current: 0.5A/PIN(Signal contact)
4-3. Rated Voltage: 30V AC/DC Per Contact
4-4. Contact Resistance: 100mΩ Max.
- ELECTRICAL MECHANICAL ENVIRONMENT:**
5-1. Dielectric withstanding Voltage: 500V AC 1 min.
5-2. Insulation Resistance: 100 MΩ Min.
5-3. Insertion Force: 1.2Kg max.
5-4. Durability: 1000 cycles

RECOMMEND PCB LAYOUT
DEFAULT TOL.: ±0.03mm
Recommend ladder steel net, steel net 0.12 mm

REV.	ECN NO.	DESCRIPTION	DATE	REV.	FINISH:	SEE NOTE	UNITS:	GENERAL TOLERANCE	DRAW:	PART NO:
F	E1703065A	优化侦测结构及增加侦测接触行程	2017.03.29	F	DATE:	09/07'2015	mm	X. ±0.25 .X ±0.15 .XX ±0.10 .XXX ±0.05	X. ±5.00 .X ±3.00 .XX ±1.00	S108-2B21F13A-1
E	E1606189A	增加尺寸管控	06/12'2016	E	SCALE:	4/1			CHECKED:	TITLE: 1.35H DOUBLE NANO_SIM & TF 3 CHOOSE 2 CARD CONN.
D	E1603092A	改善塑胶开裂	03/28'2016	D	SHEET:	1/1			APPROVE:	DRAWING NO:
					MATERIAL:					

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